

TFM-115-02-L-S

(1,27 mm) .050"

T & THROUGH-HOLE HEADER

SPECIFICATIONS

For complete specifications and recommended PCB layouts see www.samtec.com?TFM or www.samtec.com?TFML

Insulator Material: Black Liquid Crystal Polymer Terminal Material:

Phosphor Bronze Plating:

Au or Sn over 50µ" (1,27 µm) Ni Current Rating (TFM/SFM): 3.2 A per pin (1 pin powered per row)
Voltage Rating:
250 VAC mated with SFM
Operating Temp Range:
-55°C to +125°C

RoHS Compliant: Yes

Processing: Lead-Free Solderable: Yes SMT Lead Coplanarity: (0,10 mm) .004" max (05-25) (0,15 mm) .006" max (30-50)

TFM Mates with:

SFM, SFMC, SFSD

TFML Mates with:

TFM-DH Mates with:

SFM (-DH), SFMC, SFSDX (-S, -D, -SR, -DR)

 TFM

= Standard

 TFML

= Locking (-01 & -02 lead style only)

В

(5,59) .220

(5,59) .220 (2,77)

(7,37) .290 (1,97) .078

(7,37) .290 (2,77)

(9,14)

.360

N/A with 07 or -S row

C

(1,97) .078

.109

(1,97) .078 (9,14).360

(2,77) .109

(1,97) .078 (11,05) .435

В

C

LEAD STYLE (T/H)

-01

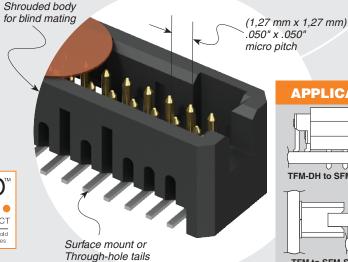
-03*

-11*

-13°

-23*





APPLICATIONS TFM-DH to SFM-DH SHOWN TFM to SFM-SH SHOWN

RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality





MATED HEIGHT

LEAD STYLE		MATED
TFM	SFM	HEIGHT*
-02	-02	(6,35) .250
-12		(8,13) .320
-22		(9,91) .390
-32		(11,81) .465
LEAD STYLE		MATED
TFM	SFM	HEIGHT*
-01	-01	(5,97) .235
-03		(5,97) .235
-11		(7,75) .305
-13		(7,75) .305
-21		(9,53) .375
-23		(9,53) .375
-31		(11,43) .450
*Processing conditions will affect mated height.		

OTHER SOLUTIONS

· Lower cost plating options. See TFC Series.

Note: Some sizes, styles and options are non-standard, non-returnable.



03, 04, 06, 08 (TFM -01 & -02 only)

05, 07, 10, 15, 20, 25, 30, 35, 40, 45, 50 (Standard sizes)

LEAD STYLE

Specify LEAD STÝLE from chart

LEAD

STYLE (SMT)

-02

-12*

-22*

-32*

S row option

N/A with 07, -DH or

(5,72) .225

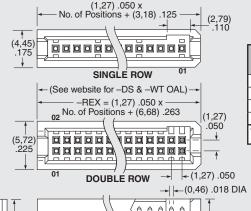
(7.49).295

(9,27) .365

(11,18) .440

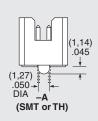
PLATING OPTION

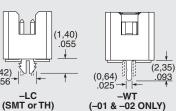
= 15µ" (0,38 µm) Gold on post, Matte Tin on tail (Call Samtec for E.L.P.™ plating option)



→ (0,36) .014

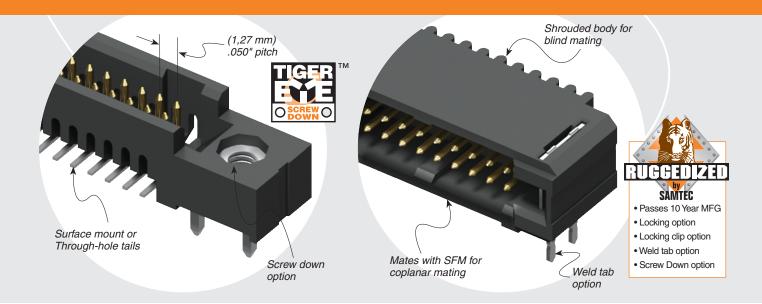
SURFACE MOUNT





(-01 & -02 ONLY)

THROUGH-HOLE



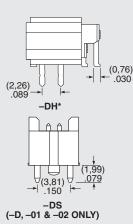
ROW OPTION

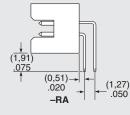
–S = Single Row (TFM only)

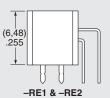
–D = Double Row

-DH*

= Double Horizontal (TFM lead style -02 only) (05 thru 50 positions only) (-TR option only available)







OPTION

Specify only -RA, -RE1 or -RE2

-RA

= Right Angle (Lead style -01 only)

–RE1

= Right Angle Elevated for (1,58 mm) .062" PCB (Requires TFM lead style -01, -D row and -WT)

–RE2

= Right Angle Elevated for (2,36 mm) .093" PCB (Requires TFM lead style -01, -D row and -WT)

Specify only –A, –LC, –DS or –WT Not available with –RA, –RE1 and –RE2 unless otherwise noted.

-A

= Alignment Pin

-LC

= Locking Clip (Manual Placement required)

-DS

-DS

= Dual Screw Down for
(1,60 mm) .062" PCB
(05, 07, 10, 15, 20, 25, 30,
35, 40 positions only)
(TFM lead styles -01 and -02 only)
(Requires -D row option)
(Mates with SFM-DS option and
SFSD/SFSDT -SS and -DS option only)
(Not available with -A, -LC,
-WT, -K, -P, -TR)

-WT

= Weld Tab

(TFM lead styles -01 and -02 only) (Required callout for -RE1 & -RE2) (Mates to SFSS/SFSD -SR and -DR option only) (05, 07, 10, 15, 20, 25, 30, 35, 40, 45, 50 positions only)

* Note: Weld tab is standard on –DH option. No need to specify –WT.

SMT lead styles only Specify only –K or –P –K



= Polyimide Film Pick & Place Pad

= Plastic Pick & Place Pad (5 positions minimum) (Not available with 5 position with -WT)

Specify -TR last

-TR

= Tape & Reel (Not available with –DS)

ALSO AVAILABLE (MOQ Required)

- · Solder nail option
- Other sizes
- Other platings

Contact Samtec.